

ORDERING INFORMATION

DEVICE	PACKAGE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZMR330FTA	SOT23	7″	8mm	3,000

DEVICE MARKING

• 330

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ABSOLUTE MAXIMUM RATINGS

Input voltage	-0.6 to 24V
Output current	100mA
Operating temperature	-55 to 125°C
Storage temperature	-65 to 150°C
Maximum junction temperature	150°C
Package power dissipation	400mW at TA = 25°C (De-rate to zero at 150°C)

The maximum power dissipation for the SOT23 package is calculated assuming that the device is mounted on a FR4 substrate measuring 15 x 15 x 0.6 mm.

Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

ELECTRICAL CHARACTERISTICS

Test Conditions T_A = 25°C, V_{in}+ = 7V, I_{out} = 10mA unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
V _{out}	Output voltage		3.217	3.3	3.383	V
		l _o = 0 to 50mA.	3.148		3.393	V
		T _j = -55 to +125°C				
		V _{in} = 5 to 24V,	3.148		3.408	V
		T _j = -55 to 125°C				
ΔV _{out}	Line regulation	V _{in} = 5 to 24V		1	10	mV
ΔV _{out}	Load regulation	I ₀ = 0 to 50mA		20	50	mV
		I _o = 0 to 10mA		13		mV
۱ _s	Supply current	T _j = -55 to 125°C		120	170	μA
ΔI _S	Supply current change	I ₀ = 0 to 50mA		5	10	μA
		V _{in} = 5 to 20V		2	10	μA
Vn	Output noise voltage	F = 10Hz to 10kHz		80		μV rms
$\Delta V_{in} / \Delta V_{out}$	Ripple rejection	V _{in} = 6 to 20V, f = 120Hz	55			dB
V _{in}	Input voltage required to maintain regulation	V _{out} = 3.217V	4.80	4.74		V

NOTES

(1) Output capacitor of 1nF is recommended.









TYPICAL CHARACTERISTICS



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PACKAGE OUTLINE



Controlling dimensions are in millimeters. Approximate conversions are given in inches

	Millin	neters	Inc	hes	DIM	Millimeters		Inches	
DIM	Min	Max	Min	Мах		Min	Max	Мах	Max
А	2.67	3.05	0.105	0.120	Н	0.33	0.51	0.013	0.020
В	1.20	1.40	0.047	0.055	К	0.01	0.10	0.0004	0.004
С	_	1.10	—	0.043	L	2.10	2.50	0.083	0.0985
D	0.37	0.53	0.015	0.021	М	0.45	0.64	0.018	0.025
F	0.085	0.15	0.0034	0.0059	N	0.95	NOM	0.0375	5 NOM
G	1.90	NOM	0.075	NOM	-	_	_	-	-

PACKAGE DIMENSIONS

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